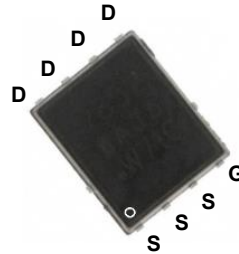
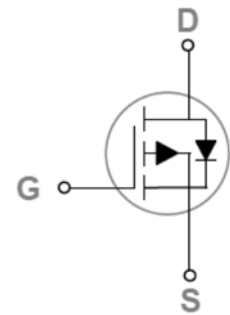


Main Product Characteristics

$V_{(BR)DSS}$	-30V
$R_{DS(ON)}$	4.5m Ω
I_D	-90A



PPAK5x6



Schematic Diagram

Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



Description

The SSFP3959 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supply and a wide variety of other applications.

Absolute Maximum Ratings ($T_C=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current – Continuous ($T_C=25^\circ\text{C}$)	I_D	-90	A
Drain Current – Continuous ($T_C=100^\circ\text{C}$)		-56	A
Drain Current – Pulsed ¹	I_{DM}	-360	A
Power Dissipation ($T_C=25^\circ\text{C}$)	P_D	136	W
Power Dissipation – Derate above 25°C		1.08	W/ $^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55 to +150	$^\circ\text{C}$
Operating Junction Temperature Range	T_J	-55 to +150	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Typ.	Max.	Unit
Thermal Resistance Junction to Ambient	$R_{\theta JA}$	---	62	$^\circ\text{C}/\text{W}$
Thermal Resistance Junction to Case	$R_{\theta JC}$	---	0.92	$^\circ\text{C}/\text{W}$

Electrical Characteristics (T_J=25°C unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =-250uA	-30	---	---	V
BV _{DSS} Temperature Coefficient	ΔBV _{DSS} /ΔT _J	Reference to 25°C, I _D =-1mA	---	-0.03	---	V/°C
Drain-Source Leakage Current	I _{DSS}	V _{DS} =-30V, V _{GS} =0V, T _J =25°C	---	---	-1	uA
		V _{DS} =-24V, V _{GS} =0V, T _J =125°C	---	---	-10	uA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	---	---	±100	nA
On Characteristics						
Static Drain-Source On-Resistance ³	R _{DS(on)}	V _{GS} =-10V, I _D =-30A	---	3.5	4.5	mΩ
		V _{GS} =-4.5V, I _D =-20A	---	5	7	mΩ
Gate Threshold Voltage	V _{GS(th)}	V _{GS} =V _{DS} , I _D =-250uA	-1.2	-1.6	-2.2	V
V _{GS(th)} Temperature Coefficient	ΔV _{GS(th)}		---	4	---	mV/°C
Forward Transconductance	g _{fs}	V _{DS} =-10V, I _D =-5A	---	25	---	S
Dynamic and Switching Characteristics						
Total Gate Charge ^{2,3}	Q _g	V _{DS} =-15V, V _{GS} =-10V, I _D =-10A	---	108	150	nC
Gate-Source Charge ^{2,3}	Q _{gs}		---	15	25	
Gate-Drain Charge ^{2,3}	Q _{gd}		---	17.4	30	
Turn-On Delay Time ^{2,3}	T _{d(on)}	V _{DD} =-15V, V _{GS} =-10V, R _G =6Ω, I _D =-1A	---	28	56	nS
Rise Time ^{2,3}	T _r		---	16	32	
Turn-Off Delay Time ^{2,3}	T _{d(off)}		---	178	340	
Fall Time ^{2,3}	T _f		---	72	140	
Input Capacitance	C _{iss}	V _{DS} =-25V, V _{GS} =0V, F=1MHz	---	6220	9000	pF
Output Capacitance	C _{oss}		---	782	1100	
Reverse Transfer Capacitance	C _{rss}		---	412	600	
Drain-Source Diode Characteristics and Maximum Ratings						
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Continuous Source Current	I _S	V _G =V _D =0V, Force Current	---	---	-90	A
Pulsed Source Current	I _{SM}		---	---	-360	A
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =-1A, T _J =25°C	---	---	-1	V

Note:

1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed, pulse width ≤ 300uS, duty cycle ≤ 2%.
3. Essentially independent of operating temperature.

Typical Electrical and Thermal Characteristic Curves

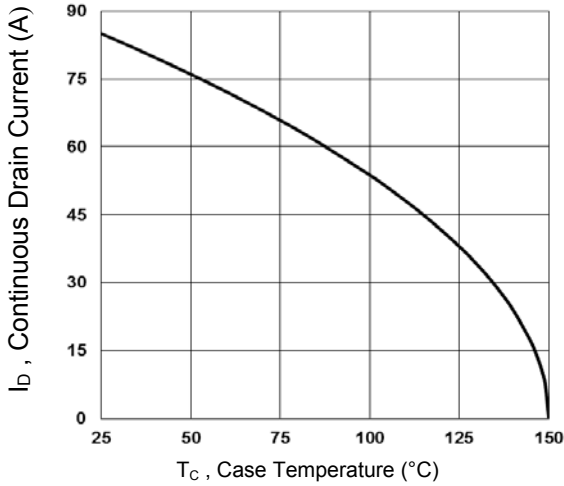


Fig.1 Continuous Drain Current vs. T_c

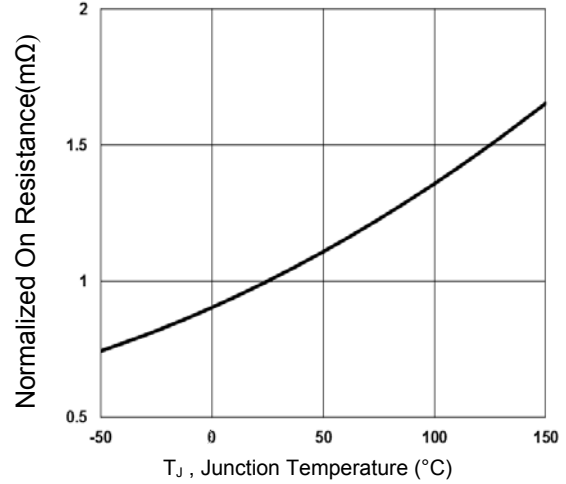


Fig.2 Normalized $R_{DS(ON)}$ vs. T_j

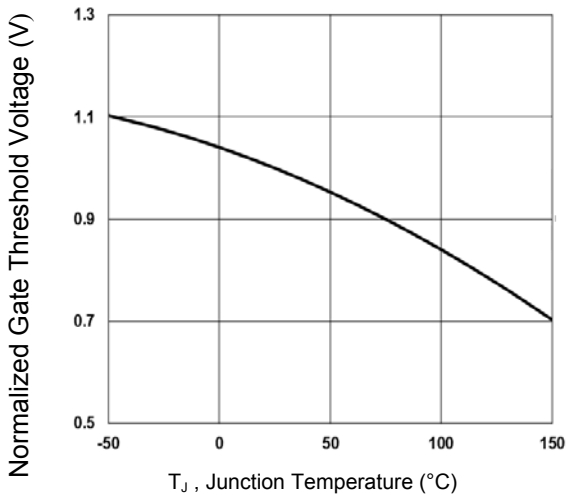


Fig.3 Normalized V_{th} vs. T_j

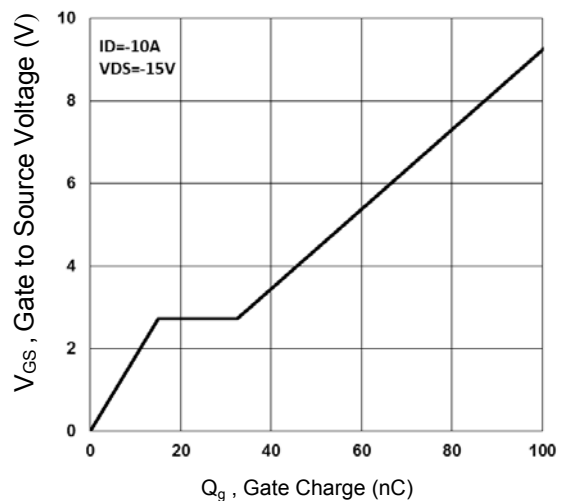


Fig.4 Gate Charge Waveform

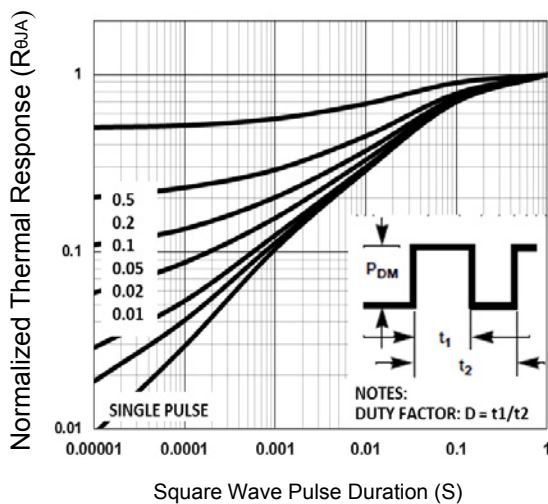


Fig.5 Normalized Transient Impedance

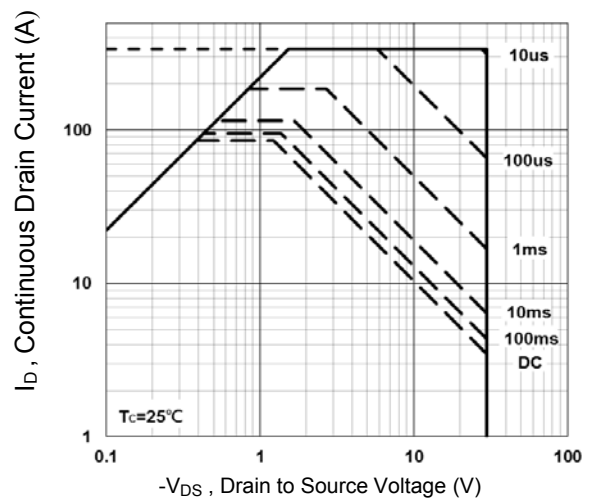


Fig.6 Maximum Safe Operation Area

Typical Electrical and Thermal Characteristic Curves

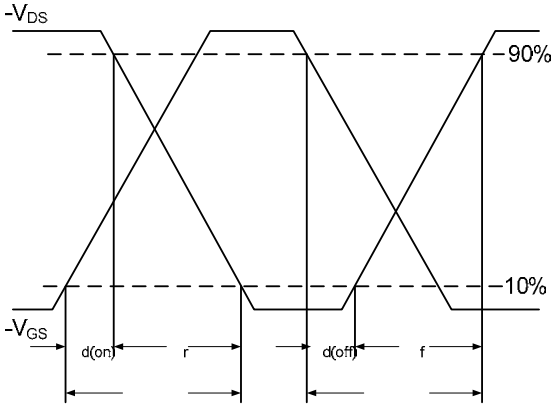


Fig.7 Switching Time Waveform

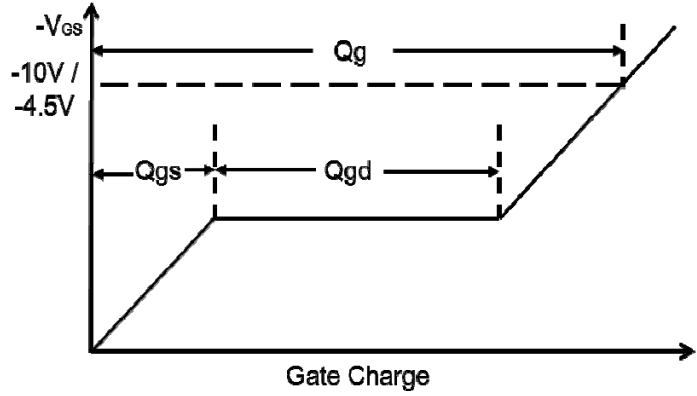
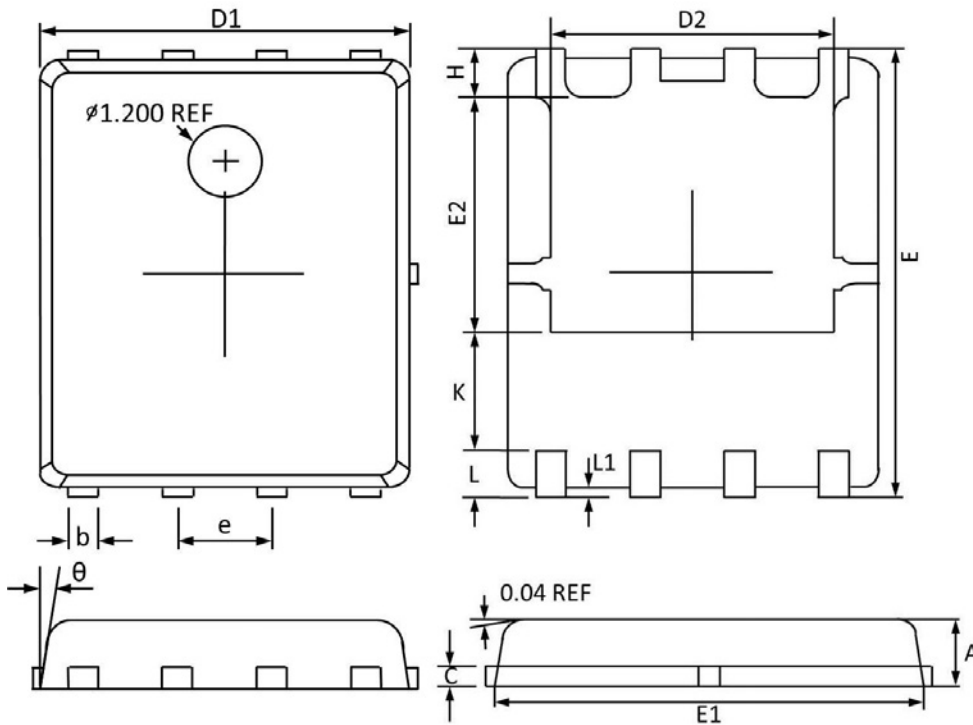


Fig.8 Gate Charge Waveform

Package Outline Dimensions PPAK5x6



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	1.100	0.800	0.043	0.031
b	0.510	0.330	0.020	0.013
C	0.300	0.200	0.012	0.008
D1	5.100	4.800	0.201	0.189
D2	4.100	3.610	0.161	0.142
E	6.200	5.900	0.244	0.232
E1	5.900	5.700	0.232	0.224
E2	3.780	3.350	0.149	0.132
e	1.27BSC		0.05BSC	
H	0.700	0.410	0.028	0.016
K	1.500	1.100	0.059	0.043
L	0.710	0.510	0.028	0.020
L1	0.200	0.060	0.008	0.002
theta	12°	0°	12°	0°